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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: 2503

Date: October 18, 1996

Examiner: S. Clark

In re Patent Application of Khandros et al.

Serial No.: 08/030,194

Filed: April 28, 1993

For: SEMICONDUCTOR CHIP ASSEMBLIES, METHODS OF MAKING SAME AND COMPONENTS FOR SAME

Assistant Commissioner for Patents Washington, D.C. 20231

AMENDMENT

Sir:

Please amend the above-identified application as follows:

In the Claims:

Cancel claims 15-19 inclusive.

REMARKS

The present amendment is responsive to the Official Action mailed July 25, 1996. Claims 1-6 and claims 20-21 were rejected under the judicially created doctrine of obviousness-type double patenting as unpatentable over claims in applicants' U.S. Patent 5,148,265. A terminal disclaimer pursuant to 37 CFR 1.321 referring to the '265 patent is transmitted herewith and it is, therefore, believed that this rejection has been overcome.

Claims 15-19 inclusive were rejected under 35 USC 102(b) on Lee et al. By the present amendment, these claims have been cancelled and accordingly, this rejection is believed overcome.

Claims 61-82 were rejected under the judicially created doctrine of obviousness-type double patenting based upon claims in applicants' U.S. Patent 5,148,266. A further terminal disclaimer pursuant to 37 CFR 1.321 referring to the '266

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class mail in an envelope addressed to Assistant Commissioner for Patents, Washington, D.C. 20231 on October 18, 1996

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